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Applicant: Iver E. ANDERSON, et al  
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## U.S. PATENT DOCUMENTS

Examiner Initial*	Document Number	Date	Name	Class	Sub Class	Filing Date
JSA	AA 4 248 905	02/1981	Harvey	427	11	01/1980
JSA	AB 4 670 217	06/1987	Henson, et al	420	562	07/1985
JSA	AC 4 695 428	09/1987	Ballentine, et al	420	561	08/1986
JSA	AD 4 758 407	07/1988	Ballentine, et al	420	560	06/1987
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	AH					
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	AJ					
	AK					

## FOREIGN PATENT DOCUMENTS

Document Number	Date	Country	Class	Sub Class	Translation Yes No
AL					
AM					
AN					
AO					
AP					

## OTHER DOCUMENTS (Including Author, Title, Date, Pages, Etc.)

JSA	AR	"Über den Aufbau des systems Silber-Kupfer-Zinn" Z. Metallkunde Bd. 50 (1959) H.10, p. 597
JSA	AS	"Developing Lead-Free Solders: A Challenge and Opportunity"; JOM, Vol. 45, No. 7, July 1993, pgs. 1 and 13; Sungho Jin

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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.